

# 74ALVCH16373

2.5 V/3.3 V 16-bit D-type transparent latch; 3-state

Rev. 04 — 31 May 2010

Product data sheet

## 1. General description

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The 74ALVCH16373 is 16-bit D-type transparent latch featuring separate D-type inputs for each latch and 3-state outputs for bus oriented applications.

Incorporates bus hold data inputs which eliminate the need for external pull-up or pull-down resistors to hold unused inputs.

One latch enable (LE) input and one output enable ( $\overline{OE}$ ) are provided per 8-bit section.

The 74ALVCH16373 consists of 2 sections of eight D-type transparent latches with 3-state true outputs. When LE is HIGH, data at the nDn inputs enter the latches. In this condition the latches are transparent, therefore a latch output will change each time its corresponding D-input changes.

When LE is LOW, the latches store the information that was present at the nDn inputs at a set-up time preceding the LOW-to-HIGH transition of LE. When  $\overline{OE}$  is LOW, the contents of the eight latches are available at the outputs. When  $\overline{OE}$  is HIGH, the outputs go to the high-impedance OFF-state. Operation of the  $\overline{OE}$  input does not affect the state of the latches.

## 2. Features and benefits

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- Wide supply voltage range from 1.2 V to 3.6 V
- Complies with JEDEC standard JESD8-B
- CMOS low power consumption
- MULTIBYTE flow-through standard pin-out architecture
- Low inductance multiple  $V_{CC}$  and GND pins for minimum noise and ground bounce
- Direct interface with TTL levels
- All data inputs have bus hold
- Output drive capability 50  $\Omega$  transmission lines at 85 °C
- Current drive  $\pm 24$  mA at  $V_{CC} = 3.0$  V

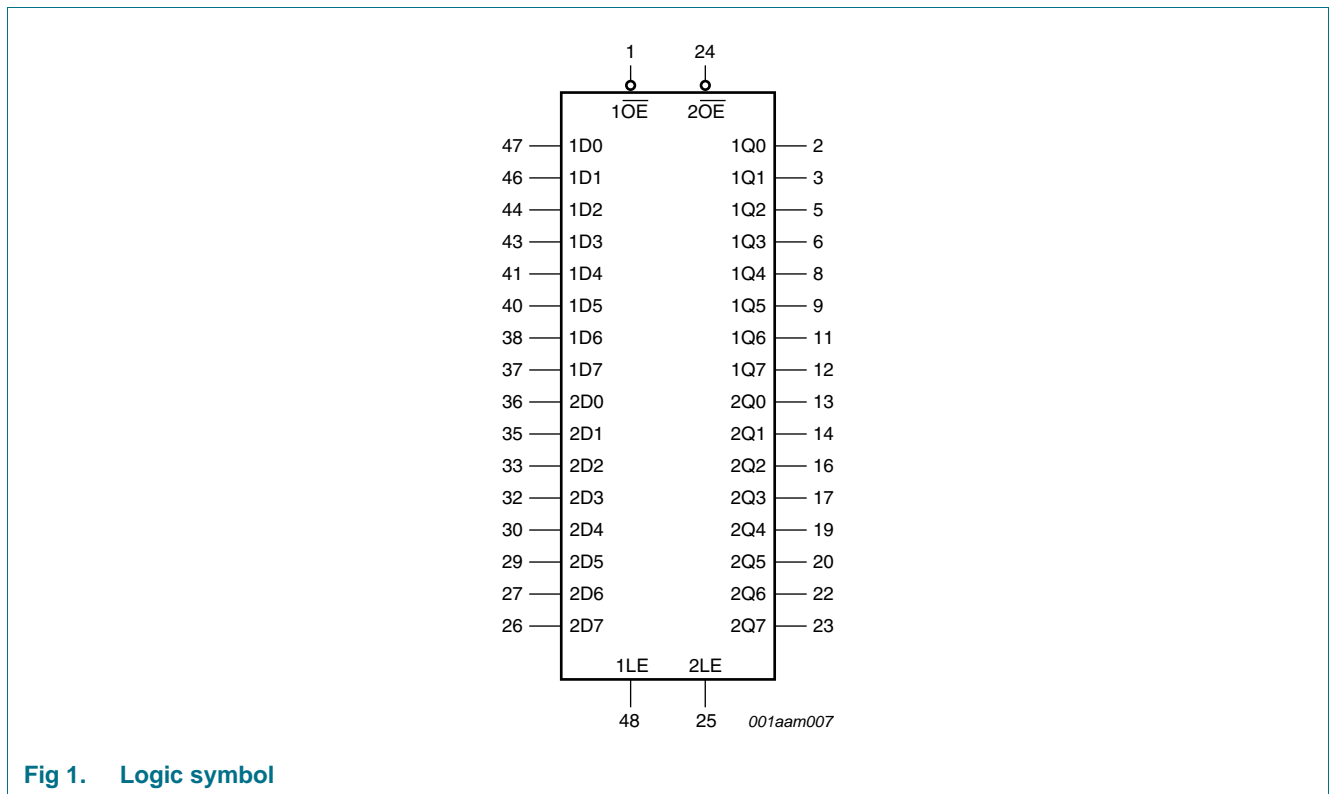


### 3. Ordering information

Table 1. Ordering information

| Type number     | Temperature range | Package |  |          |
|-----------------|-------------------|---------|--|----------|
|                 |                   | Name    | Description  | Version  |
| 74ALVCH16373DL  | -40 °C to +85 °C  | SSOP48  | plastic shrink small outline package; 48 leads; body width 7.5 mm      | SOT370-1 |
| 74ALVCH16373DGG | -40 °C to +85 °C  | TSSOP48 | plastic thin shrink small outline package; 48 leads; body width 6.1 mm | SOT362-1 |

### 4. Functional diagram



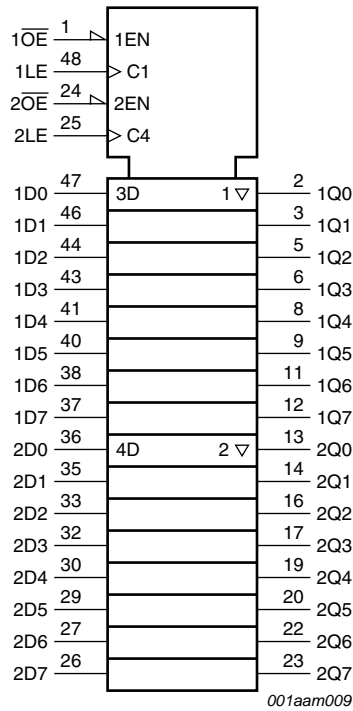


Fig 2. IEC logic symbol

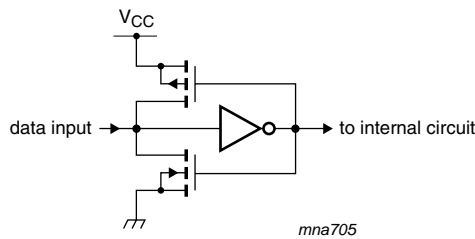


Fig 3. Bus hold circuit

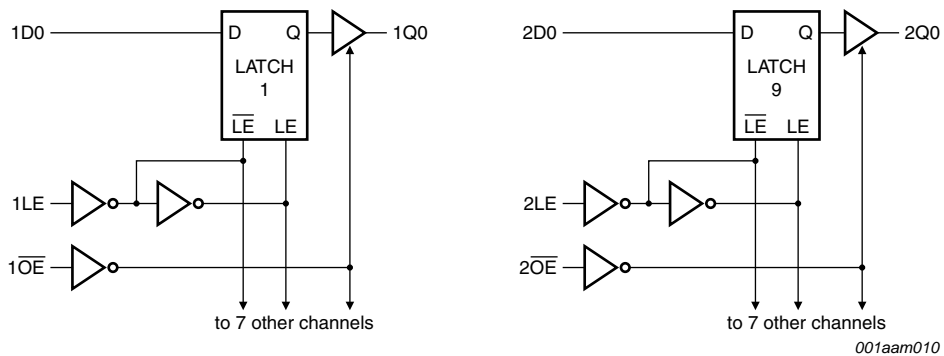
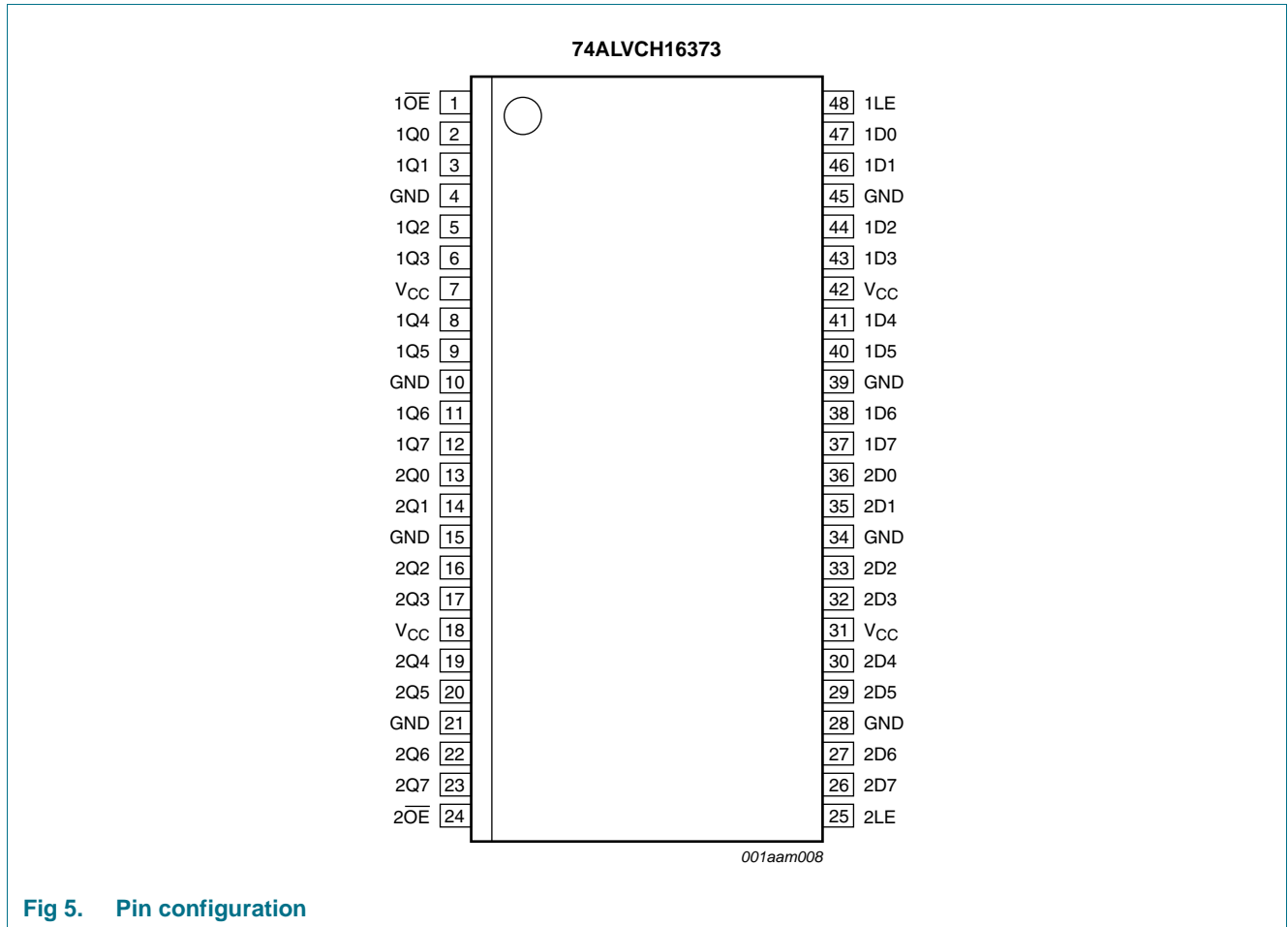


Fig 4. Logic diagram

5. Pinning information

5.1 Pinning



## 5.2 Pin description

Table 2. Pin description

| Symbol                           | Pin                            | Description                      |
|----------------------------------|--------------------------------|----------------------------------|
| $1\overline{OE}, 2\overline{OE}$ | 1, 24                          | output enable input (active LOW) |
| 1Q0 to 1Q7                       | 2, 3, 5, 6, 8, 9, 11, 12       | data outputs                     |
| 2Q0 to 2Q7                       | 13, 14, 16, 17, 19, 20, 22, 23 | data outputs                     |
| GND                              | 4, 10, 15, 21, 28, 34, 39, 45  | ground (0 V)                     |
| V <sub>CC</sub>                  | 7, 18, 31, 42                  | positive supply voltage          |
| 1D0 to 1D7                       | 47, 46, 44, 43, 41, 40, 38, 37 | data inputs                      |
| 2D0 to 2D7                       | 36, 35, 33, 32, 30, 29, 27, 26 | data inputs                      |
| 1LE, 2LE                         | 48, 25                         | latch enable input (active HIGH) |

## 6. Functional description

### 6.1 Function table

Table 3. Function table<sup>[1]</sup>

| Inputs |     |     | Internal latches | Outputs nQn | Operating mode                              |
|--------|-----|-----|------------------|-------------|---|
| nOE    | nLE | nDn |                  |             |   |
| L      | H   | L   | L                | L           | enable and read register (transparent mode) |
| L      | H   | H   | H                | H           |   |
| L      | L   | l   | L                | L           | latch and read register (hold mode)         |
| L      | L   | h   | H                | H           |   |
| H      | L   | l   | L                | Z           | latch register and disable outputs          |
| H      | L   | h   | H                | Z           |   |

[1] H = HIGH voltage level;  
 L = LOW voltage level;  
 h = HIGH voltage level one set-up time prior to the LOW-to-HIGH LE transition;  
 l = LOW voltage level one set-up time prior to the LOW-to-HIGH LE transition;  
 Z = high-impedance OFF-state.

## 7. Limiting values

**Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol    | Parameter               | Conditions                      | Min      | Max            | Unit |
|-----------|-------------------------|---------------------------------|----------|----------------|------|
| $V_{CC}$  | supply voltage          |                                 | -0.5     | +4.6           | V    |
| $I_{IK}$  | input clamping current  | $V_I < 0$ V                     | -50      | -              | mA   |
| $V_I$     | input voltage           | control inputs                  | [1] -0.5 | +4.6           | V    |
|           |                         | data inputs                     | [1] -0.5 | $V_{CC} + 0.5$ | V    |
| $I_{OK}$  | output clamping current | $V_O > V_{CC}$ or $V_O < 0$ V   | -        | $\pm 50$       | mA   |
| $V_O$     | output voltage          |                                 | [1] -0.5 | $V_{CC} + 0.5$ | V    |
| $I_O$     | output current          | $V_O = 0$ V to $V_{CC}$         | -        | $\pm 50$       | mA   |
| $I_{CC}$  | supply current          |                                 | -        | 100            | mA   |
| $I_{GND}$ | ground current          |                                 | -100     | -              | mA   |
| $T_{stg}$ | storage temperature     |                                 | -65      | +150           | °C   |
| $P_{tot}$ | total power dissipation | $T_{amb} = -40$ °C to $+125$ °C |          |                |      |
|           |                         | SSOP48 package                  | [2] -    | 850            | mW   |
|           |                         | TSSOP48 package                 | [3] -    | 600            | mW   |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] Above 55 °C the value of  $P_{tot}$  derates linearly with 11.3 mW/K.

[3] Above 55 °C the value of  $P_{tot}$  derates linearly with 8 mW/K.

## 8. Recommended operating conditions

**Table 5. Recommended operating conditions**

| Symbol              | Parameter                           | Conditions                | Min | Typ | Max      | Unit |
|---------------------|-------------------------------------|---------------------------|-----|-----|----------|------|
| $V_{CC}$            | supply voltage                      | maximum speed performance |     |     |          |      |
|                     |                                     | $C_L = 30$ pF             | 2.3 | -   | 2.7      | V    |
|                     |                                     | $C_L = 50$ pF             | 3.0 | -   | 3.6      | V    |
| $V_I$               | input voltage                       | low voltage applications  | 1.2 | -   | 3.6      | V    |
|                     |                                     | data inputs               | 0   | -   | $V_{CC}$ | V    |
|                     |                                     | control inputs            | 0   | -   | 5.5      | V    |
| $V_O$               | output voltage                      |                           | 0   | -   | $V_{CC}$ | V    |
| $T_{amb}$           | ambient temperature                 | in free air               | -40 | -   | +85      | °C   |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 2.3$ V to 3.0 V | 0   | -   | 20       | ns/V |
|                     |                                     | $V_{CC} = 3.0$ V to 3.6 V | 0   | -   | 10       | ns/V |

## 9. Static characteristics

**Table 6. Static characteristics**

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol                                    | Parameter                       | Conditions  | Min                   | Typ <sup>[1]</sup>     | Max                | Unit |
|---|---------------------------------|---|-----------------------|------------------------|--------------------|------|
| <b>T<sub>amb</sub> = -40 °C to +85 °C</b> |                                 |   |                       |                        |                    |      |
| V <sub>IH</sub>                           | HIGH-level input voltage        | V <sub>CC</sub> = 1.2 V   | V <sub>CC</sub>       | -                      | -                  | V    |
|   |                                 | V <sub>CC</sub> = 1.8 V   | 0.7V <sub>CC</sub>    | 0.9                    | -                  | V    |
|   |                                 | V <sub>CC</sub> = 2.3 V to 2.7 V  | 1.7                   | 1.2                    | -                  | V    |
|   |                                 | V <sub>CC</sub> = 2.7 V to 3.6 V  | 2.0                   | 1.5                    | -                  | V    |
| V <sub>IL</sub>                           | LOW-level input voltage         | V <sub>CC</sub> = 1.2 V   | -                     | -                      | 0                  | V    |
|   |                                 | V <sub>CC</sub> = 1.8 V   | -                     | 0.9                    | 0.2V <sub>CC</sub> | V    |
|   |                                 | V <sub>CC</sub> = 2.3 V to 2.7 V  | -                     | 1.2                    | 0.7                | V    |
|   |                                 | V <sub>CC</sub> = 2.7 V to 3.6 V  | -                     | 1.5                    | 0.8                | V    |
| V <sub>OH</sub>                           | HIGH-level output voltage       | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>   |                       |                        |                    |      |
|   |                                 | I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 1.8 V to 3.6 V                                    | V <sub>CC</sub> - 0.2 | V <sub>CC</sub>        | -                  | V    |
|   |                                 | I <sub>O</sub> = -6 mA; V <sub>CC</sub> = 1.8 V   | V <sub>CC</sub> - 0.4 | V <sub>CC</sub> - 0.1  | -                  | V    |
|   |                                 | I <sub>O</sub> = -6 mA; V <sub>CC</sub> = 2.3 V   | V <sub>CC</sub> - 0.3 | V <sub>CC</sub> - 0.08 | -                  | V    |
|   |                                 | I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.3 V  | V <sub>CC</sub> - 0.5 | V <sub>CC</sub> - 0.17 | -                  | V    |
|   |                                 | I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.7 V  | V <sub>CC</sub> - 0.5 | V <sub>CC</sub> - 0.14 | -                  | V    |
|   |                                 | I <sub>O</sub> = -18 mA; V <sub>CC</sub> = 2.3 V  | V <sub>CC</sub> - 0.6 | V <sub>CC</sub> - 0.26 | -                  | V    |
|   |                                 | I <sub>O</sub> = -24 mA; V <sub>CC</sub> = 3.0 V  | V <sub>CC</sub> - 1.0 | V <sub>CC</sub> - 0.28 | -                  | V    |
| V <sub>OL</sub>                           | LOW-level output voltage        | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>   |                       |                        |                    |      |
|   |                                 | I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 1.8 V to 3.6 V                                     | -                     | 0                      | 0.20               | V    |
|   |                                 | I <sub>O</sub> = 6 mA; V <sub>CC</sub> = 1.8 V  | -                     | 0.09                   | 0.30               | V    |
|   |                                 | I <sub>O</sub> = 6 mA; V <sub>CC</sub> = 2.3 V  | -                     | 0.07                   | 0.20               | V    |
|   |                                 | I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.3 V   | -                     | 0.15                   | 0.40               | V    |
|   |                                 | I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V   | -                     | 0.14                   | 0.40               | V    |
|   |                                 | I <sub>O</sub> = 18 mA; V <sub>CC</sub> = 2.3 V   | -                     | 0.23                   | 0.60               | V    |
|   |                                 | I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V   | -                     | 0.27                   | 0.55               | V    |
| I <sub>I</sub>                            | input leakage current           | V <sub>CC</sub> = 1.8 V to 3.6 V  |                       |                        |                    |      |
|   |                                 | control input; V <sub>I</sub> = 5.5 V or GND  | -                     | 0.1                    | 5                  | μA   |
|   |                                 | data input; V <sub>I</sub> = V <sub>CC</sub> or GND   | -                     | 0.1                    | 5                  | μA   |
| I <sub>OZ</sub>                           | OFF-state output current        | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>O</sub> = V <sub>CC</sub> or GND |                       |                        |                    |      |
|   |                                 | V <sub>CC</sub> = 1.8 V to 2.7 V  | -                     | 0.1                    | 5                  | μA   |
|   |                                 | V <sub>CC</sub> = 2.7 V to 3.6 V  | -                     | 0.1                    | 10                 | μA   |
| I <sub>LIZ</sub>                          | OFF-state input leakage current | V <sub>I</sub> = V <sub>CC</sub> or GND   |                       |                        |                    |      |
|   |                                 | V <sub>CC</sub> = 1.8 V to 2.7 V  | -                     | 0.1                    | 10                 | μA   |
|   |                                 | V <sub>CC</sub> = 3.6 V   | -                     | 0.1                    | 15                 | μA   |
| I <sub>CC</sub>                           | supply current                  | V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A;                                |                       |                        |                    |      |
|   |                                 | V <sub>CC</sub> = 1.8 V to 2.7 V  | -                     | 0.2                    | 40                 | μA   |
|   |                                 | V <sub>CC</sub> = 2.7 V to 3.6 V  | -                     | 0.2                    | 40                 | μA   |

**Table 6. Static characteristics ...continued**

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol          | Parameter                       | Conditions  | Min | Typ <sup>[1]</sup> | Max  | Unit    |
|-----------------|---------------------------------|---|-----|--------------------|------|---------|
| $\Delta I_{CC}$ | additional supply current       | $V_I = V_{CC} - 0.6$ V; $I_O = 0$ A;<br>$V_{CC} = 2.7$ V to 3.6 V |     |                    |      |         |
|                 |                                 | per control input   | -   | 5                  | 500  | $\mu$ A |
|                 |                                 | per data I/O input  | -   | 150                | 750  | $\mu$ A |
| $I_{BHL}$       | bus hold LOW current            | $V_{CC} = 2.3$ V; $V_I = 0.7$ V                                   | [2] | 45                 | -    | $\mu$ A |
|                 |                                 | $V_{CC} = 3.0$ V; $V_I = 0.8$ V                                   | [2] | 75                 | 150  | $\mu$ A |
| $I_{BHH}$       | bus hold HIGH current           | $V_{CC} = 2.3$ V; $V_I = 1.7$ V                                   | [2] | -45                | -    | $\mu$ A |
|                 |                                 | $V_{CC} = 3.0$ V; $V_I = 2.0$ V                                   | [2] | -75                | -175 | $\mu$ A |
| $I_{BHLO}$      | bus hold LOW overdrive current  | $V_{CC} = 2.7$ V  | [2] | 300                | -    | $\mu$ A |
|                 |                                 | $V_{CC} = 3.6$ V  | [2] | 450                | -    | $\mu$ A |
| $I_{BHHO}$      | bus hold HIGH overdrive current | $V_{CC} = 2.7$ V  | [2] | -300               | -    | $\mu$ A |
|                 |                                 | $V_{CC} = 3.6$ V  | [2] | -450               | -    | $\mu$ A |
| $C_I$           | input capacitance               |   | -   | 5.0                | -    | pF      |

[1] All typical values are measured at  $T_{amb} = 25$  °C.

[2] Valid for data inputs of bus hold parts only.

## 10. Dynamic characteristics

**Table 7. Dynamic characteristics**At recommended operating conditions. Voltages are referenced to GND (ground = 0 V); test circuit [Figure 10](#).

| Symbol  | Parameter         | Conditions                               | Min | Typ <sup>[1]</sup> | Max | Unit |    |
|---|-------------------|--|-----|--------------------|-----|------|----|
| <b><math>T_{amb} = -40</math> °C to <math>+85</math> °C</b> |                   |  |     |                    |     |      |    |
| $t_{pd}$  | propagation delay | nDn to nQn; see <a href="#">Figure 6</a> | [2] |                    |     |      |    |
|   |                   | $V_{CC} = 1.2$ V                         |     | -                  | 8.8 | -    | ns |
|   |                   | $V_{CC} = 1.8$ V                         |     | 1.5                | 3.2 | 5.7  | ns |
|   |                   | $V_{CC} = 2.3$ V to 2.7 V                | [3] | 1.0                | 2.1 | 3.9  | ns |
|   |                   | $V_{CC} = 2.7$ V                         |     | 1.0                | 2.3 | 3.7  | ns |
|   |                   | $V_{CC} = 3.0$ V to 3.6 V                | [4] | 1.0                | 2.1 | 3.3  | ns |
|   |                   | nLE to nQn; see <a href="#">Figure 7</a> | [2] |                    |     |      |    |
|   |                   | $V_{CC} = 1.2$ V                         |     | -                  | 7.4 | -    | ns |
|   |                   | $V_{CC} = 1.8$ V                         |     | 1.5                | 3.4 | 5.9  | ns |
|   |                   | $V_{CC} = 2.3$ V to 2.7 V                | [3] | 1.0                | 2.2 | 3.9  | ns |
| $t_{en}$  | enable time       | $V_{CC} = 2.7$ V                         |     | 1.0                | 2.2 | 3.5  | ns |
|   |                   | $V_{CC} = 3.0$ V to 3.6 V                | [4] | 1.0                | 2.2 | 3.2  | ns |
|   |                   | nOE to nQn; see <a href="#">Figure 8</a> | [2] |                    |     |      |    |
|   |                   | $V_{CC} = 1.2$ V                         |     | -                  | 8.9 | -    | ns |
|   |                   | $V_{CC} = 1.8$ V                         |     | 1.5                | 4.0 | 7.3  | ns |
|   |                   | $V_{CC} = 2.3$ V to 2.7 V                | [3] | 1.0                | 2.6 | 5.2  | ns |
|   |                   | $V_{CC} = 2.7$ V                         |     | 1.0                | 2.9 | 4.9  | ns |
|   |                   | $V_{CC} = 3.0$ V to 3.6 V                | [4] | 1.0                | 2.3 | 4.2  | ns |



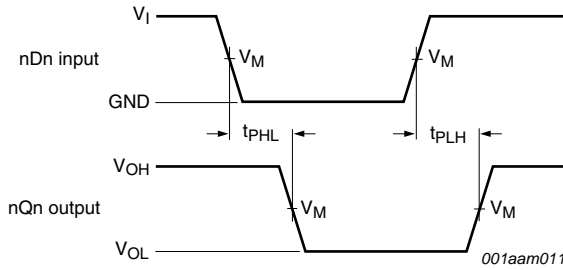
**Table 7. Dynamic characteristics ...continued**

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V); test circuit [Figure 10](#).

| Symbol           | Parameter                     | Conditions   | Min                 | Typ <sup>[1]</sup> | Max  | Unit |    |
|------------------|-------------------------------|--|---------------------|--------------------|------|------|----|
| t <sub>dis</sub> | disable time                  | n $\overline{OE}$ to nQn; see <a href="#">Figure 8</a> |                     |                    |      |      |    |
|                  |                               | V <sub>CC</sub> = 1.2 V                                | -                   | 8.9                | -    | ns   |    |
|                  |                               | V <sub>CC</sub> = 1.8 V                                | 1.5                 | 3.2                | 5.6  | ns   |    |
|                  |                               | V <sub>CC</sub> = 2.3 V to 2.7 V                       | <a href="#">[3]</a> | 1.0                | 2.2  | 4.1  | ns |
|                  |                               | V <sub>CC</sub> = 2.7 V                                | 1.0                 | 3.1                | 4.7  | ns   |    |
| t <sub>w</sub>   | pulse width                   | nLE HIGH; see <a href="#">Figure 7</a>                 |                     |                    |      |      |    |
|                  |                               | V <sub>CC</sub> = 1.8 V                                | 3.5                 | 1.0                | -    | ns   |    |
|                  |                               | V <sub>CC</sub> = 2.3 V to 2.7 V                       | <a href="#">[3]</a> | 3.0                | 1.0  | -    | ns |
|                  |                               | V <sub>CC</sub> = 2.7 V                                | 3.0                 | 1.0                | -    | ns   |    |
|                  |                               | V <sub>CC</sub> = 3.0 V to 3.6 V                       | <a href="#">[4]</a> | 2.5                | 1.0  | -    | ns |
| t <sub>su</sub>  | set-up time                   | nDn to nLE; see <a href="#">Figure 9</a>               |                     |                    |      |      |    |
|                  |                               | V <sub>CC</sub> = 1.8 V                                | 1.0                 | -0.1               | -    | ns   |    |
|                  |                               | V <sub>CC</sub> = 2.3 V to 2.7 V                       | <a href="#">[3]</a> | 1.0                | -0.1 | -    | ns |
|                  |                               | V <sub>CC</sub> = 2.7 V                                | 1.0                 | -0.1               | -    | ns   |    |
| t <sub>h</sub>   | hold time                     | nDn to nLE; see <a href="#">Figure 9</a>               |                     |                    |      |      |    |
|                  |                               | V <sub>CC</sub> = 1.8 V                                | 1.2                 | 0.1                | -    | ns   |    |
|                  |                               | V <sub>CC</sub> = 2.3 V to 2.7 V                       | <a href="#">[3]</a> | 1.5                | 0.2  | -    | ns |
|                  |                               | V <sub>CC</sub> = 2.7 V                                | 1.5                 | 0.4                | -    | ns   |    |
| C <sub>PD</sub>  | power dissipation capacitance | per flip-flop; V <sub>I</sub> = GND to V <sub>CC</sub> |                     |                    |      |      |    |
|                  |                               | outputs enabled  | -                   | 16                 | -    | pF   |    |
|                  |                               | outputs disabled                                       | -                   | 10                 | -    | pF   |    |

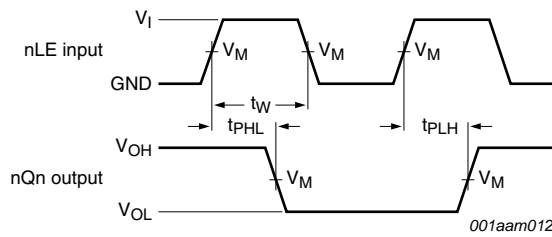
- [1] All typical values are measured at T<sub>amb</sub> = 25 °C.
- [2] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.  
t<sub>en</sub> is the same as t<sub>PZL</sub> and t<sub>PZH</sub>.  
t<sub>dis</sub> is the same as t<sub>PLZ</sub> and t<sub>PHZ</sub>.
- [3] Typical values are measured at V<sub>CC</sub> = 2.5 V.
- [4] Typical values are measured at V<sub>CC</sub> = 3.3 V.
- [5] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).  
P<sub>D</sub> = C<sub>PD</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>i</sub> × N + Σ(C<sub>L</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>o</sub>) where:  
f<sub>i</sub> = input frequency in MHz; f<sub>o</sub> = output frequency in MHz;  
C<sub>L</sub> = output load capacitance in pF;  
V<sub>CC</sub> = supply voltage in Volts;  
N = number of inputs switching;  
Σ(C<sub>L</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>o</sub>) = sum of the outputs.

11. Waveforms



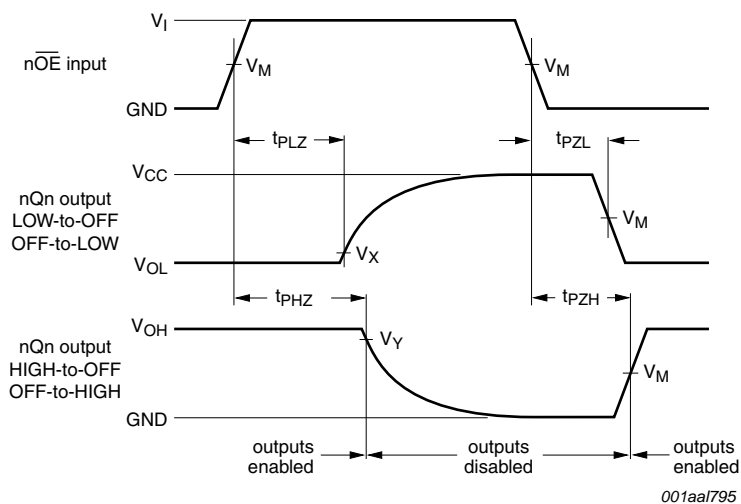
Measurement points are given in [Table 8](#).  
 $V_{OL}$  and  $V_{OH}$  are typical output levels that occur with the output load.

**Fig 6. Propagation delay, input (nDn) to data output (nQn)**



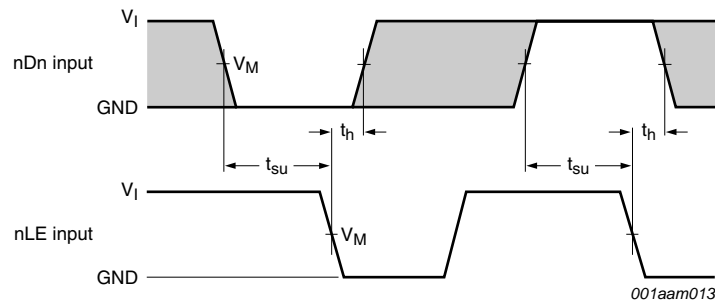
Measurement points are given in [Table 8](#).  
 $V_{OL}$  and  $V_{OH}$  are typical output levels that occur with the output load.

**Fig 7. Propagation delay, latch enable input (nLE) to data output (nQn), and pulse width**



Measurement points are given in [Table 8](#).  
 $V_{OL}$  and  $V_{OH}$  are typical output levels that occur with the output load.

**Fig 8. 3-state enable and disable times**



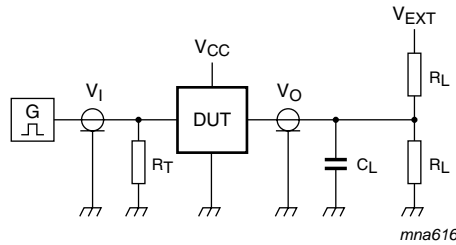
The shaded areas indicate when the input is permitted to change for predictable output performance.

**Fig 9. Data setup and hold times for input (nDn) to input (nLE)**

**Table 8. Measurement points**

| Supply voltage             | Input    |       | Output |                   |                   |
|----------------------------|----------|-------|--------|-------------------|-------------------|
| $V_{CC}$                   | $V_I$    | $V_M$ | $V_M$  | $V_X$             | $V_Y$             |
| 2.3 V to 2.7 V and < 2.3 V | $V_{CC}$ | 0.5   | 0.5    | $V_{OL} + 0.15 V$ | $V_{OH} - 0.15 V$ |
| 2.7 V                      | 2.7 V    | 2.7 V | 1.5 V  | $V_{OL} + 0.3 V$  | $V_{OH} - 0.3 V$  |
| 3.0 V to 3.6 V             | 2.7 V    | 2.7 V | 1.5 V  | $V_{OL} + 0.3 V$  | $V_{OH} - 0.3 V$  |

12. Test information



Test data is given in [Table 9](#).

Definitions for test circuit:

$R_L$  = Load resistance.

$C_L$  = Load capacitance including jig and probe capacitance.

$R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

$V_{EXT}$  = External voltage for measuring switching times.

Fig 10. Load circuit for measuring switching times

Table 9. Test data

| Supply voltage             | Input    |               | Load  |              | $V_{EXT}$          |                    |                    |
|----------------------------|----------|---------------|-------|--------------|--------------------|--------------------|--------------------|
| $V_{CC}$                   | $V_I$    | $t_r, t_f$    | $C_L$ | $R_L$        | $t_{PLH}, t_{PHL}$ | $t_{PLZ}, t_{PZL}$ | $t_{PHZ}, t_{PZH}$ |
| 2.3 V to 2.7 V and < 2.3 V | $V_{CC}$ | $\leq 2.0$ ns | 30 pF | 500 $\Omega$ | open               | $2 \times V_{CC}$  | GND                |
| 2.7 V                      | 2.7 V    | 2.5 ns        | 50 pF | 500 $\Omega$ | open               | $2 \times V_{CC}$  | GND                |
| 3.0 V to 3.6 V             | 2.7 V    | 2.5 ns        | 50 pF | 500 $\Omega$ | open               | $2 \times V_{CC}$  | GND                |

13. Package outline

SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1

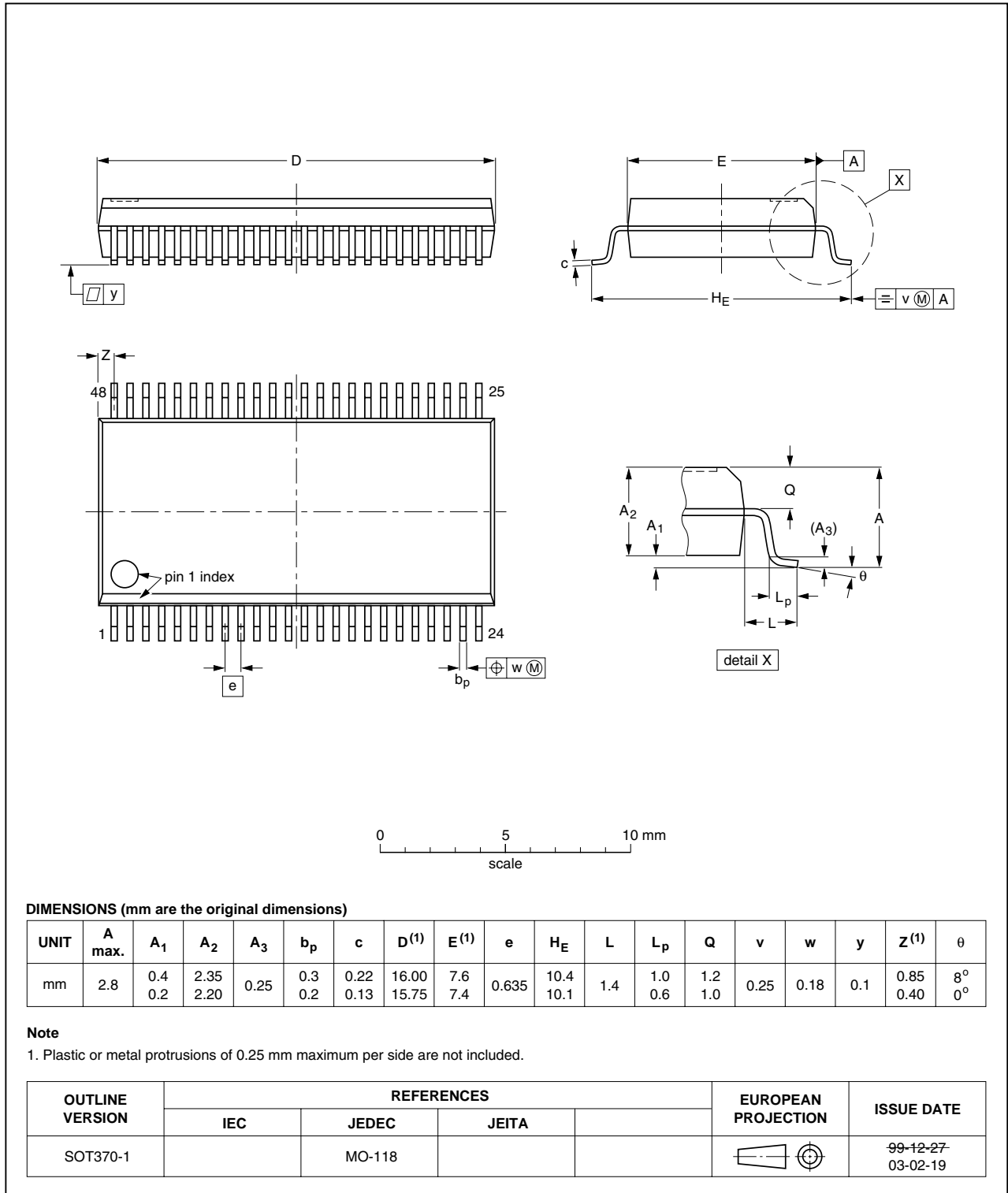


Fig 11. Package outline SOT370-1 (SSOP48)

TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1 mm

SOT362-1

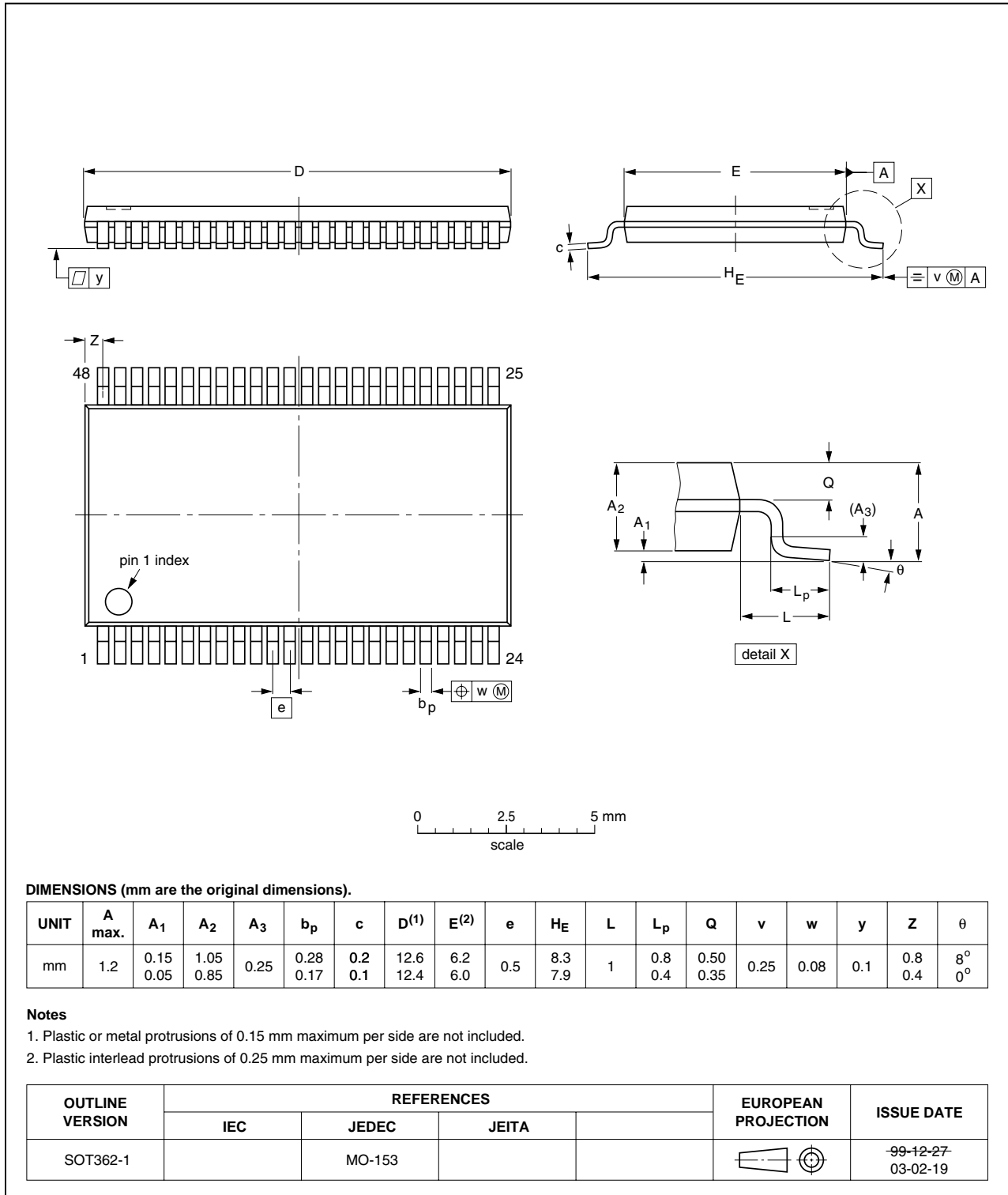


Fig 12. Package outline SOT362-1 (TSSOP48)

## 14. Abbreviations

Table 10. Abbreviations

| Acronym | Description                             |
|---------|---|
| CMOS    | Complementary Metal-Oxide Semiconductor |
| DUT     | Device Under Test                       |
| TTL     | Transistor-Transistor Logic             |

## 15. Revision history

Table 11. Revision history

| Document ID    | Release date | Data sheet status     | Change notice | Supersedes     |
|----------------|--------------|-----------------------|---------------|----------------|
| 74ALVCH16373_4 | 20100531     | Product data sheet    | -             | 74ALVCH16373_3 |
| Modifications: |              |                       |               |                |
|                |              |                       |               |                |
|                |              |                       |               |                |
|                |              |                       |               |                |
|                |              |                       |               |                |
| 74ALVCH16373_3 | 19990920     | Product specification | -             | 74ALVCH16373_2 |
| 74ALVCH16373_2 | 19980629     | Product specification | -             | 74ALVCH16373_1 |
| 74ALVCH16373_1 | 19970321     | Product specification | -             | -              |

## 16. Legal information

### 16.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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